

FAST GATE TURN-OFF THYRISTORS

Thyristors in SOT-93 envelopes capable of being turned both on and off via the gate. They are suitable for use in high-frequency inverters, power supplies, motor control etc. The devices have no reverse blocking capability; for reverse blocking operation use with a series diode, for reverse conducting operation use with an anti-parallel diode. The anode is connected to the mounting base.

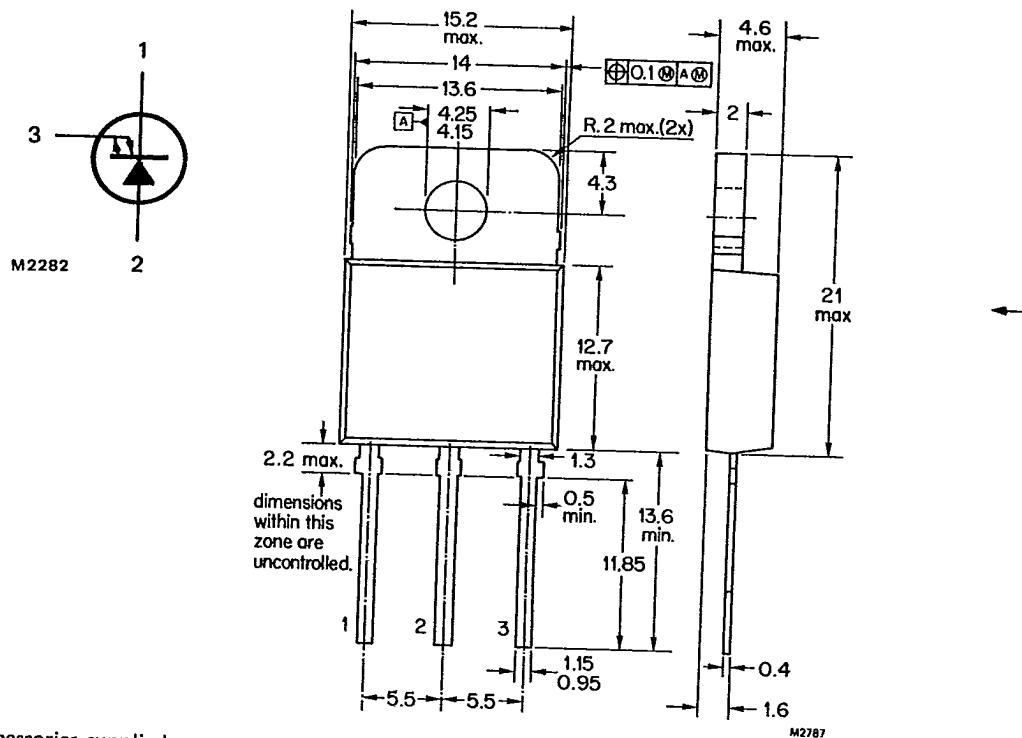
QUICK REFERENCE DATA

		BTS59-850R			1000R	1200R	
		max.	850		1000	1200	
Repetitive peak off-state voltage	V_{DRM}						V
Non-repetitive peak on-state current	I_{TSM}	max.			100		A
Controllable anode current	I_{TCRM}	max.			50		A
Average on-state current	$I_{T(AV)}$	max.			15		A
Fall time	t_f	<			250		ns

MECHANICAL DATA

Dimensions in mm

Fig.1 SOT-93; anode connected to mounting base



Accessories supplied on request: see data sheets Mounting instructions and accessories for SOT-93 envelopes.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC134)

Anode to cathode

		BTS59-850R	1000R	1200R	
Transient off-state voltage	V_{DSM}	max. 1000	1100	1300	V*
Repetitive peak off-state voltage	V_{DRM}	max. 850	1000	1200	V*
Working off-state voltage	V_{DW}	max. 600	800	1000	V*
Continuous off-state voltage	V_D	max. 500	650	750	V*

Average on-state current (averaged over any 20 ms period) up to $T_{mb} = 85^\circ\text{C}$

$I_{T(AV)}$	max.	15	A
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Controllable anode current

I_{TCRM}	max.	50	A
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Non-repetitive peak on-state current

 $t = 10$ ms; half-sinewave; $T_j = 120^\circ\text{C}$ prior to surge

I_{TSM}	max.	100	A
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 I^2t for fusing; $t = 10$ ms

I^2t	max.	50	A^2s
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Total power dissipation up to $T_{mb} = 25^\circ\text{C}$

P_{tot}	max.	105	W
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Gate to cathode

Repetitive peak current

 $T_j = 120^\circ\text{C}$ prior to surgegate-cathode forward; $t = 10$ ms;

half-sinewave

gate-cathode reverse; $t = 20$ μs

I_{GFM}	max.	25	A
I_{GRM}	max.	25	A

Average power dissipation (averaged over any 20 ms period)

$P_{G(AV)}$	max.	5.0	W
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Temperatures

Storage temperature

T_{stg}		-40 to $+125$	$^\circ\text{C}$
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Operating junction temperature

T_j	max.	120	$^\circ\text{C}$
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THERMAL RESISTANCEFrom mounting base to heatsink;
with heatsink compound

$R_{th\ mb-h}$	=	0.2	K/W
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From junction to mounting base

$R_{th\ j-mb}$	=	0.9	K/W
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* Measured with gate-cathode connected together.

Fast gate turn-off thyristors

BTS59 SERIES

T-25-15

CHARACTERISTICS

Anode to cathode

On-state voltage

 $I_T = 10 \text{ A}; I_G = 0.5 \text{ A}; T_j = 120^\circ \text{C}$ $V_T < 2.3 \text{ V}^*$ Rate of rise of off-state voltage that will not trigger any off-state device; exponential method
 $V_D = 2/3 V_{D\text{max}}; V_{GR} = 5 \text{ V}; T_j = 120^\circ \text{C}$ $dV_D/dt < 10 \text{ kV}/\mu\text{s}$ Rate of rise of off-state voltage that will not trigger any device following conduction, linear method
 $I_T = 20 \text{ A}; V_D = V_{DRM\text{max}}; V_{GR} = 10 \text{ V}; T_j = 120^\circ \text{C}$ $dV_D/dt < 1.0 \text{ kV}/\mu\text{s}$

Off-state current

 $V_D = V_{D\text{max}}; T_j = 120^\circ \text{C}$ $I_D < 5.0 \text{ mA}$ Latching current; $T_j = 25^\circ \text{C}$ $I_L \text{ typ. } 1.5 \text{ A}^{**}$

Gate to cathode

Voltage that will trigger all devices

 $V_D = 12 \text{ V}; T_j = 25^\circ \text{C}$ $V_{GT} > 1.5 \text{ V}$

Current that will trigger all devices

 $V_D = 12 \text{ V}; T_j = 25^\circ \text{C}$ $I_{GT} > 300 \text{ mA}$

Minimum reverse breakdown voltage

 $I_{GR} = 1.0 \text{ mA}$ $V_{(BR)GR} > 10 \text{ V}$

Switching characteristics (resistive load)

Turn-on when switched to $I_T = 10 \text{ A}$ from $V_D = 250 \text{ V}$ with $I_{GF} = 1.5 \text{ A}; T_j = 25^\circ \text{C}$

delay time

rise time

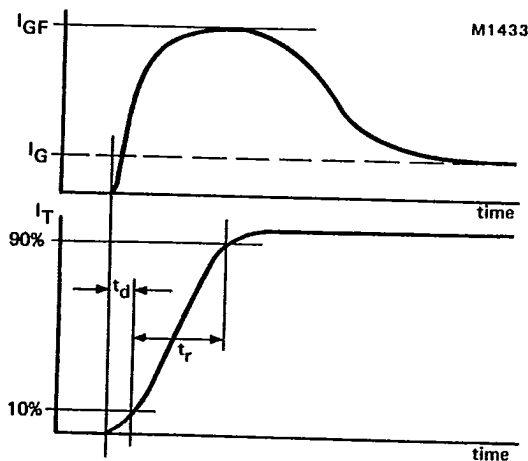
 $t_d < 0.3 \mu\text{s}$
 $t_r < 1.5 \mu\text{s}$ 

Fig.2 Waveforms

* Measured under pulse conditions to avoid excessive dissipation.

** Below latching level the device behaves like a transistor with a gain dependent on current.

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Turn-off when switched from $I_T = 10 \text{ A}$ to $V_D = V_{D\max}$;

storage time

 t_s $\angle$ 0.60 μs

fall time

 t_f $\angle$ 0.25 μ s

IGR

 $\angle$

10 A

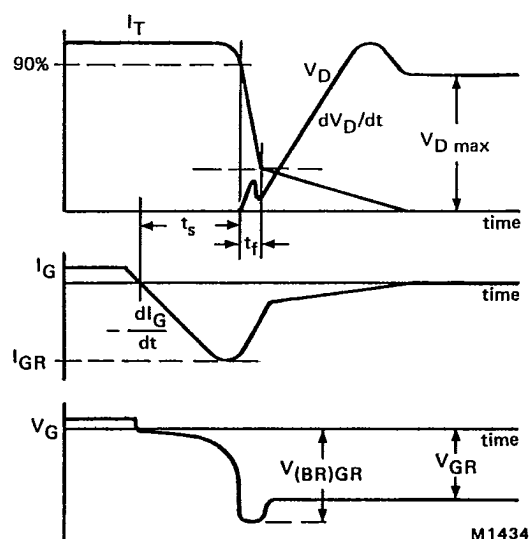


Fig.3 Waveforms.

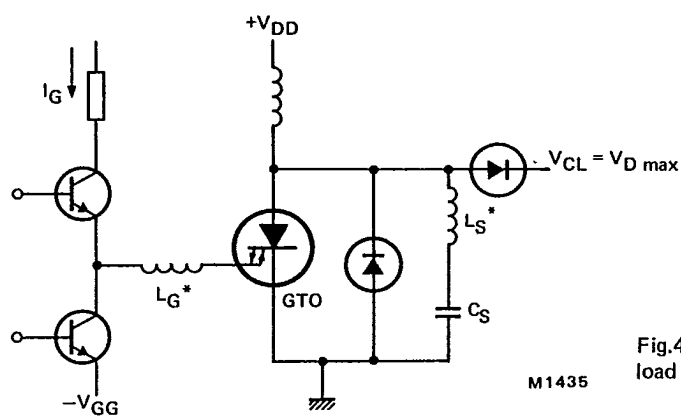


Fig.4 Inductive load test circuit.

* Indicates stray series inductance only

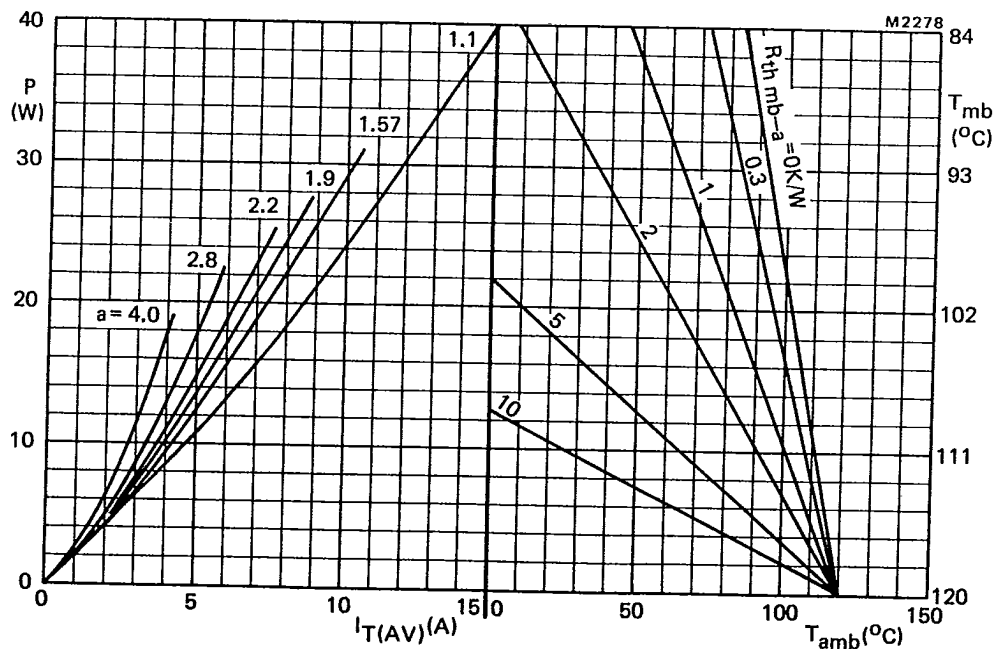


Fig.5 The right hand part shows the interrelationship between the power (derived from the left-hand part) and the maximum permissible temperatures.

$$a = \text{form factor} = \frac{I_T(\text{RMS})}{I_T(\text{AV})}$$

P = power excluding switching losses.

BTS59 SERIES

T-25-15

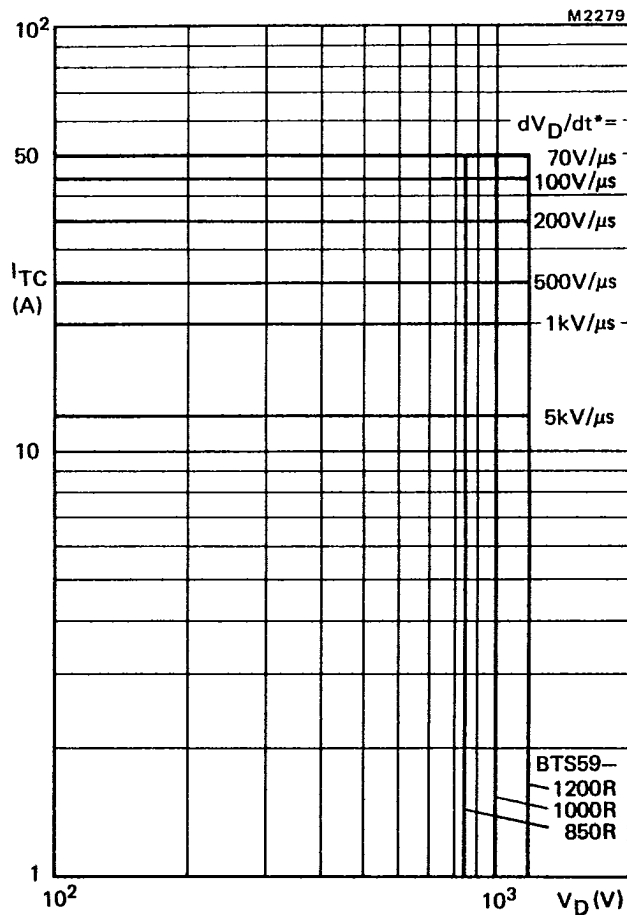


Fig.6 Anode current which can be turned off versus anode voltage; inductive load; $V_{GR} = 10$ V; $L_G \leq 0.5 \mu\text{H}$; $L_S \leq 0.25 \mu\text{H}$; $T_j = 120^\circ\text{C}$.
 $*dV_D/dt$ is calculated from I_T/C_S .

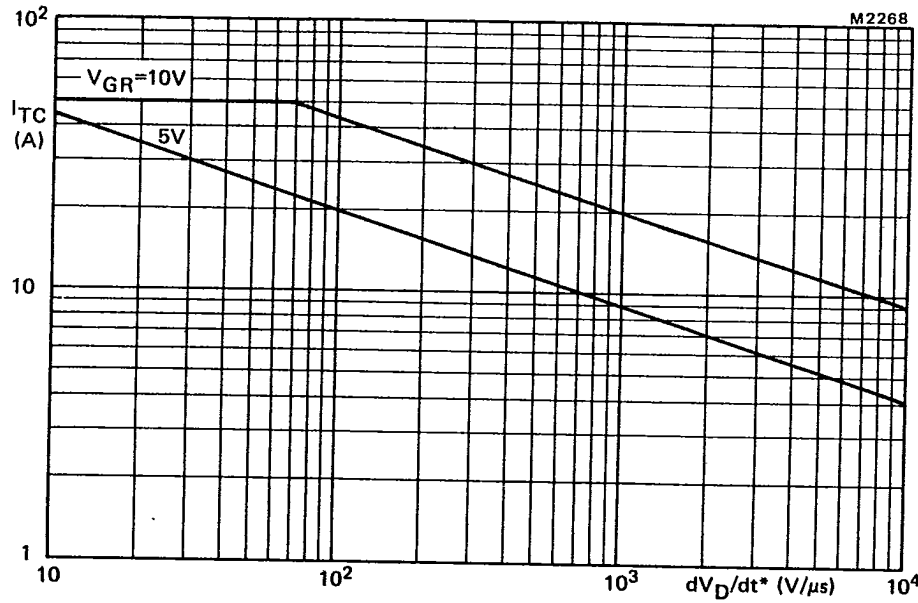


Fig.7 Anode current which can be turned off versus applied dV_D/dt^* ; inductive load;
 $L_G \leq 0.5 \mu H$; $L_S \leq 0.25 \mu H$; $T_j = 120^\circ C$. * dV_D/dt is calculated from I_T/C_S .

BTS59 SERIES

T-25 - 15

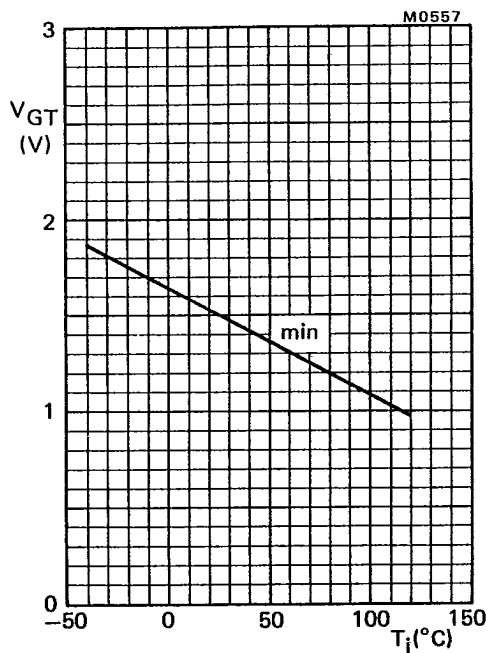


Fig.8 Minimum gate voltage that will trigger all devices as a function of junction temperature; $V_D = 12$ V.

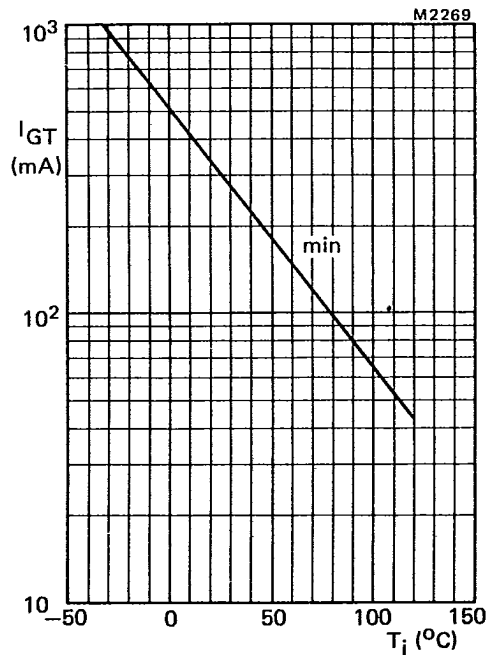


Fig.9 Minimum gate current that will trigger all devices as a function of junction temperature; $V_D = 12$ V.

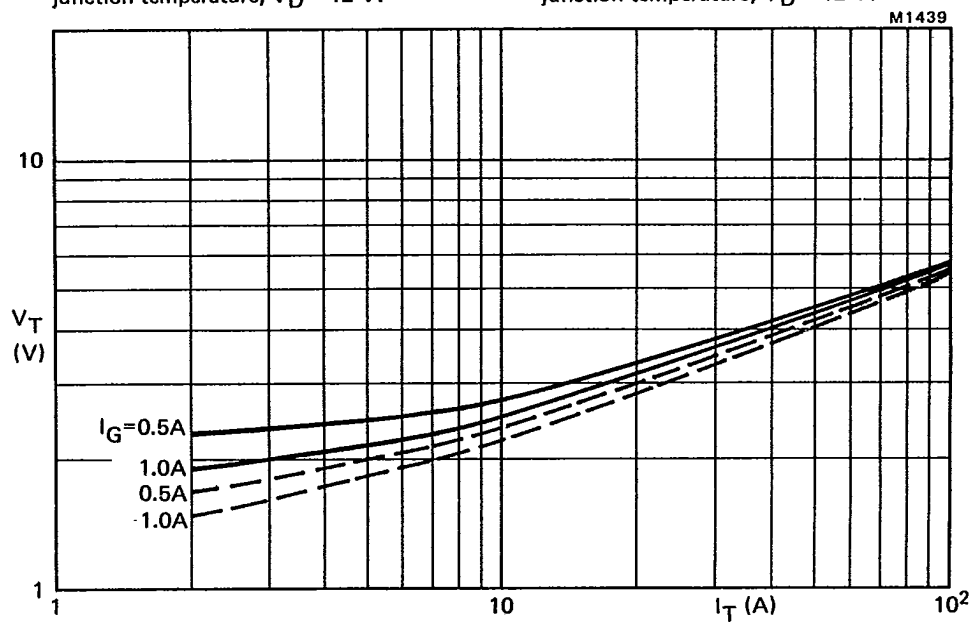


Fig.10 Maximum V_T versus I_T ; — $T_j = 25$ °C; - - - $T_j = 120$ °C.

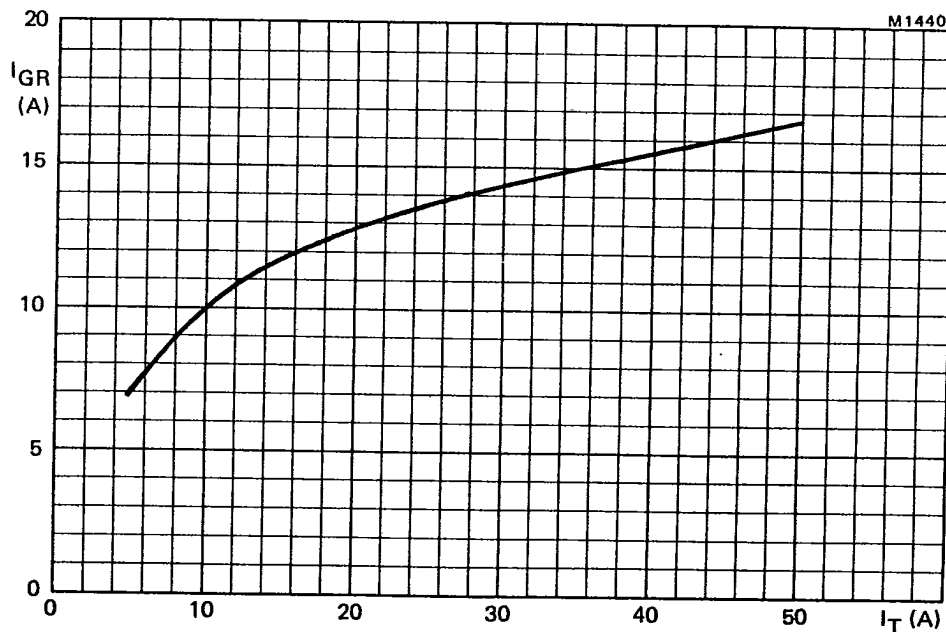


Fig.11 Peak reverse gate current versus anode current at turn-off; inductive load;
 $V_{GR} = 10$ V; $I_G = 0.5$ A; $L_G = 0.4$ μ H; $T_j = 120$ °C; maximum values.

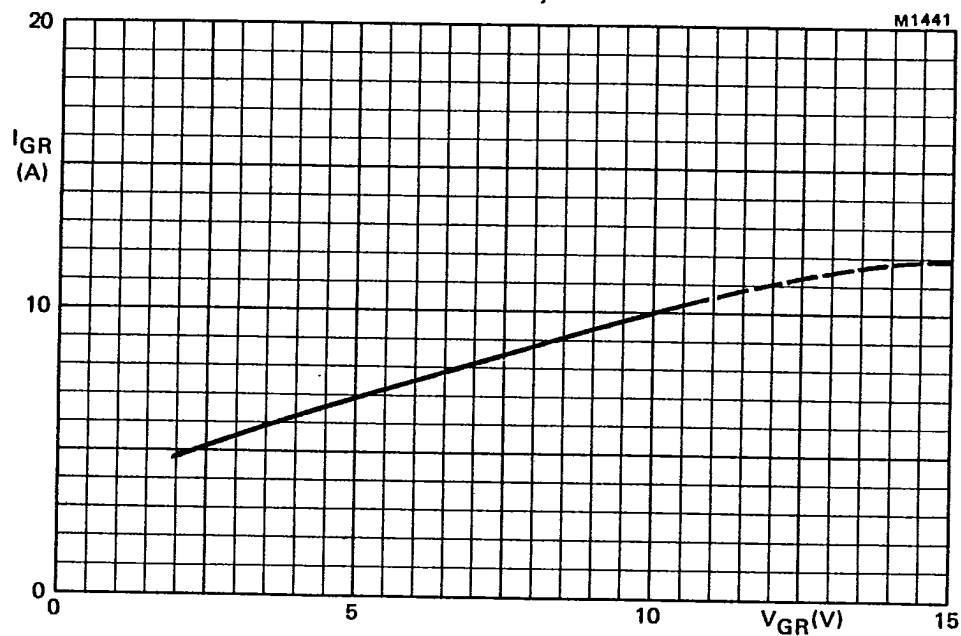


Fig.12 Peak reverse gate current versus applied reverse gate voltage; inductive load;
 $I_T = 10$ A; $I_G = 0.5$ A, $L_G = 0.4$ μ H; $T_j = 120$ °C; maximum values.

T-25-15

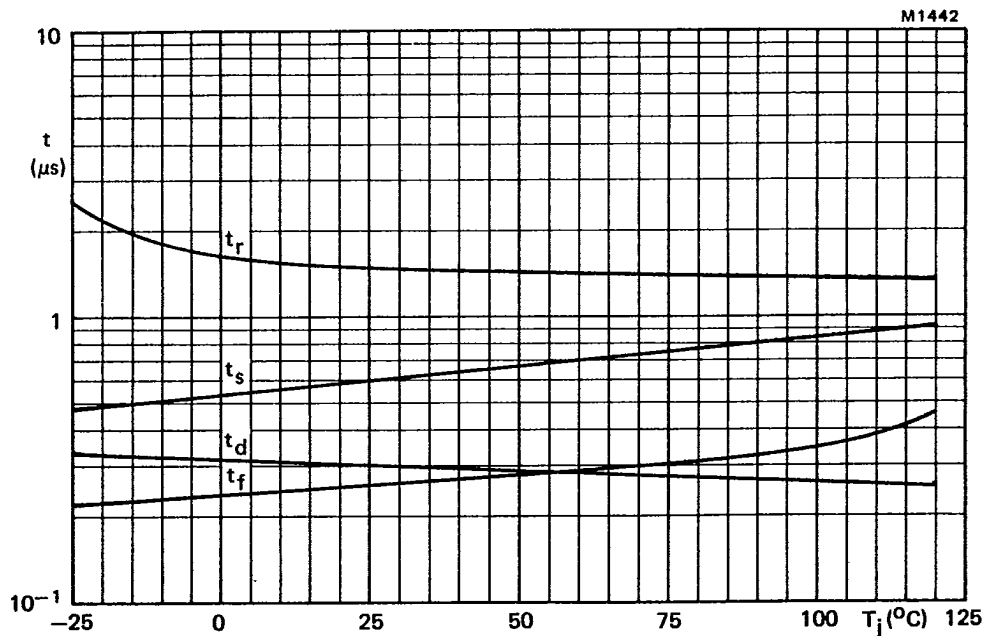


Fig.13 Switching times as a function of junction temperature; $V_D \geq 250$ V; $I_T = 10$ A;
 $I_{GF} = 1.0$ A; $V_{GR} = 10$ V; $I_G = 0.5$ A; $L_G = 0.4$ μH ; maximum values.

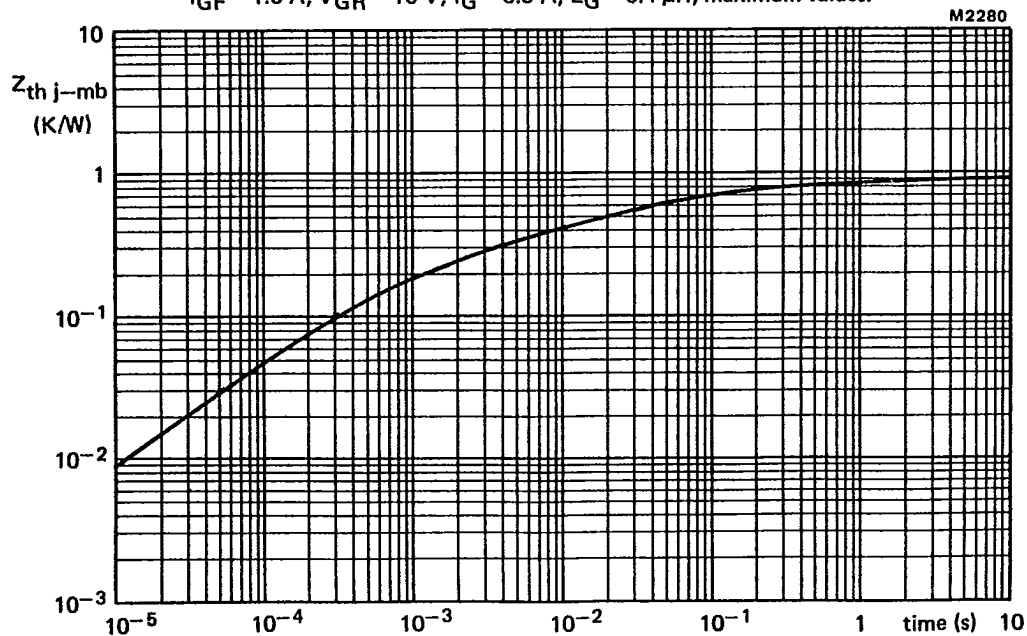


Fig.14 Transient thermal impedance.

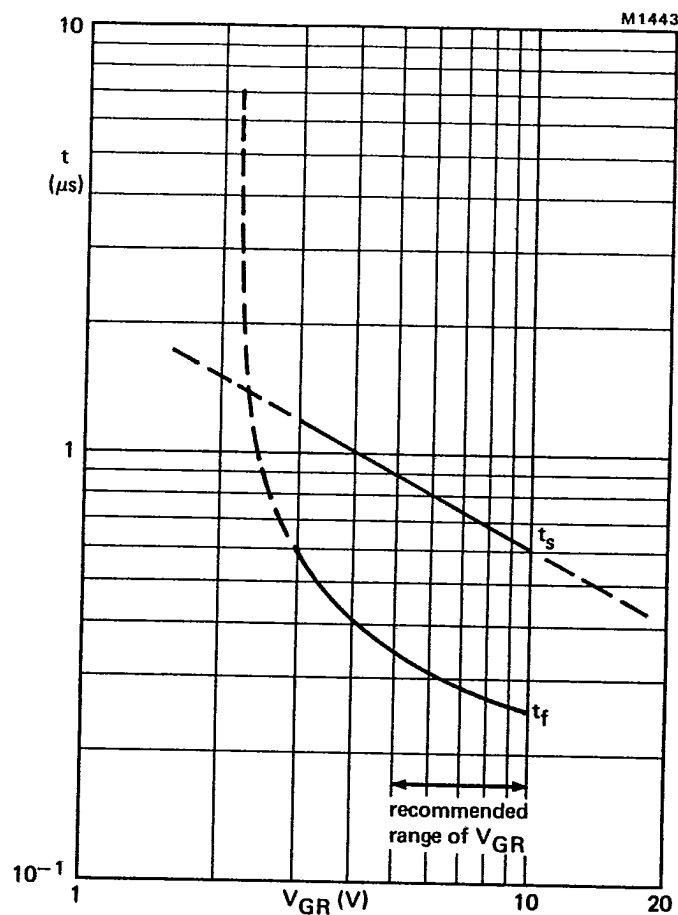


Fig.15 Storage and fall times versus applied reverse gate voltage; inductive load; $I_T = 10$ A; $I_G = 0.5$ A; $L_G = 0.4$ μ H; $T_j = 25$ °C; maximum values.

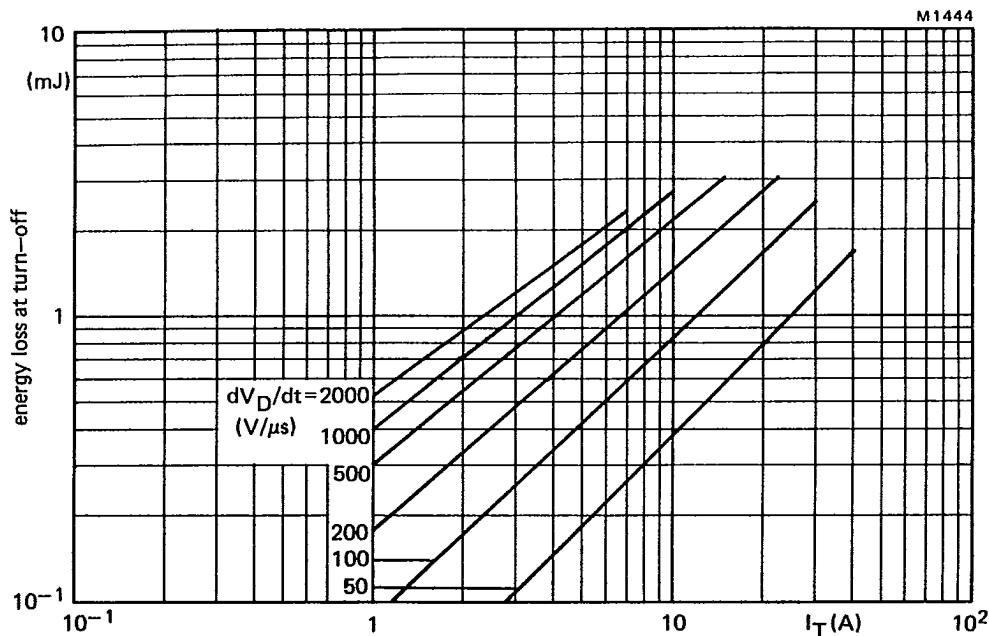


Fig.16 Maximum energy loss at turn-off (per cycle) as a function of anode current and applied dV_D/dt (calculated from I_T/C_S); dV_D/dt linear up to $V_{Dmax} = 600$ V; $V_{GR} = 10$ V; $I_G = 0.5$ A; $L_G \leq 0.5 \mu H$; $L_S \leq 0.25 \mu H$; $T_j = 120^\circ C$.

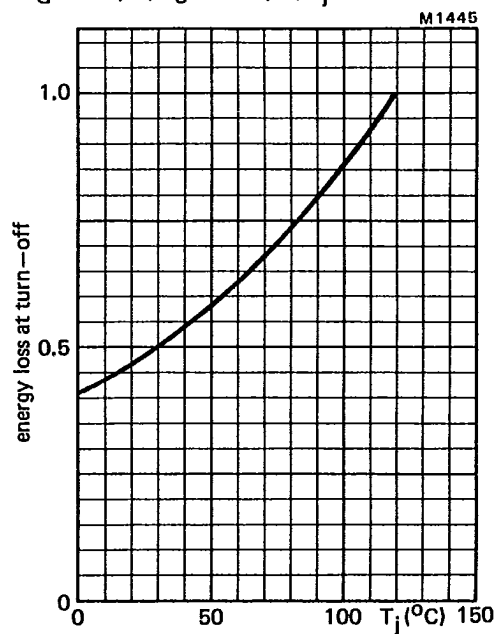


Fig.17 Energy loss at turn off as a function of junction temperature; $I_G = 0.5$ A; $V_{GR} = 10$ V. Normalised to $T_j = 120^\circ C$.